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June 2016

FFD10UP20S 10 A, 200 V, Ultrafast Diode

Features

- Ultrafast Recovery, $T_{rr} = 20.8 \text{ ns}$ (@ $I_F = 10 \text{ A}$)
- Max Forward Voltage, V_F = 1.15 V (@ T_C = 25°C)
- Reverse Voltage: V_{RRM} = 200 V
- · Avalanche Energy Rated
- · RoHS Compliant

Applications

- SMPS, Power Switching Circuits
- · Output Rectifiers
- Freewheeling Diodes

Description

The FFD10UP20S is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power as and industrial applicationa as welder and UPS application.





1,4 Cathode 3. Anode

Absolut N. n katings T_C = 25°C unless otherwise noted

6 . 1	Parameter	Rating	Unit
M	k Repetitive Peverse Voliage	200	V
V _R ,	Working Peak Reverse Voltage	200	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 115°C	10	Α
I _{FSM}	l lo.า-repetitive r'eak Surge Current CDHz Single Half-Sine V'a e	100	Α
$T_J, T_{S, G}$	Operating and Storage Temperature Range	-65 to +175	°C

Thermal Characteristics

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.0	°C/W

Package Marking and Ordering Information

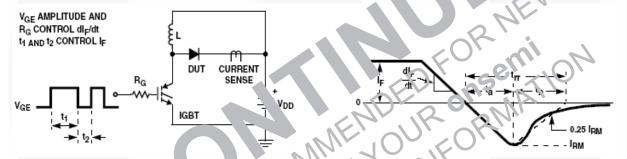
Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFD10UP20S	F10UP20S	TO-252(D-PAK)	Reel	13" Dia	N/A	2500

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Min.	Тур.	Max.	Unit	
V _F *	Maximum Instantaneous Forward Voltage $I_F = 10 \text{ A}$ $I_F = 10 \text{ A}$	$T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$			1.15 1.10	V
I _R *	Maximum Instantaneous Reverse Current @ rated V _R	$T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$		-	100 500	μА
t _{rr} I _{rr} Q _{rr}	Reverse Recovery Time Reverse Recovery Current Reverse Recovery Charge (I _F = 10 A, di _F /dt = 200 A/µs, V _R =130 V)		20.8 2.8 28.5	- - -	ns A nC	
t _{rr}	Maximum Reverse Recovery Time (I _F = 1 A, di _F /dt = 100 A/μs)	-	-	35	ns	
W _{AVL}	Avalanche Energy (L = 40 mH)	10		-	mJ	

^{*} Pulse Test: Pulse Width = 300μs, Duty Cycle = 2%

Test Circuit and Waveforms



Jule 1. iode leverse Recovery Test Circuit & Waveform

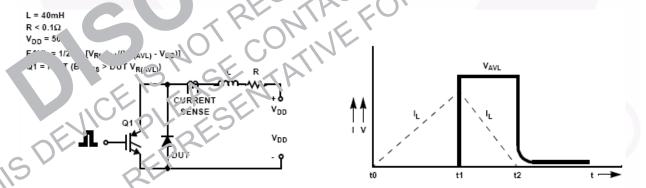


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

Typical Performance Characteristics

Figure 3. Typical Forward Voltage Drop vs. Forward Current

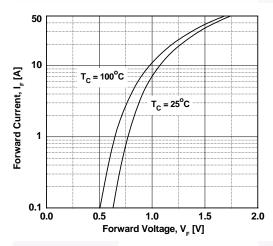


Figure 4. Typical Reverse Current vs. Reverse Voltage

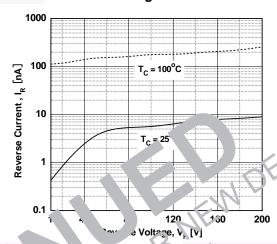
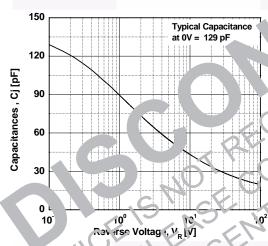


Figure 5. Typical Junction Capacitance



Four S. 15, al Reverse Recovery Time vs. dig/dt

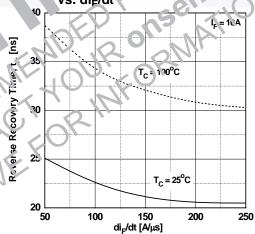


Figure 7. Typical Reverse Recovery

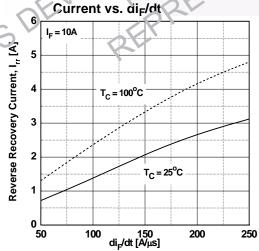
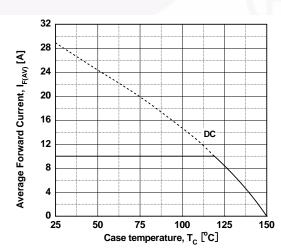
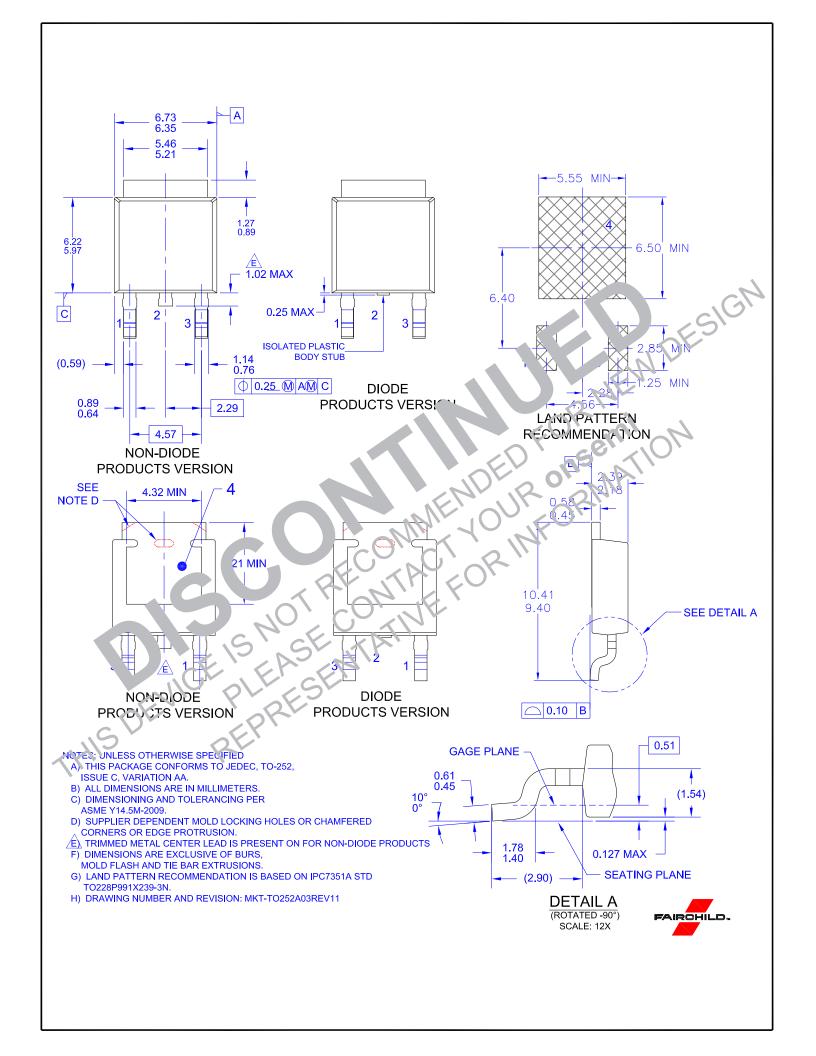


Figure 8. Forward Current Derating Curve









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Definition of Terms				
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